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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/643,946	08/23/2000	Kevin J. Torek	M4065.0166/P166-A	2940
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DICKSTEIN SHAPIRO MORIN & OSHINSKY LLP 2101 L STREET NW WASHINGTON, DC 20037-1526			EXAMINER	
			VINH, LAN	
			ART UNIT	PAPER NUMBER
			1765	<i>ii</i> –
			DATE MAILED: 01/21/2003	/

Please find below and/or attached an Office communication concerning this application or proceeding.

Office Action Summary  Description:  Og/643,946  Examiner  Art Unit					
Office Action Summary Examiner Art Unit					
LAN VINH 1765					
The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply					
A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION.  - Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.  - If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely.  - If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.  - Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C.§ 133).  - Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).  Status					
1) Responsive to communication(s) filed on <u>18 November 2002</u> .					
2a) ☐ This action is <b>FINAL</b> . 2b) ☑ This action is non-final.					
3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.					
Disposition of Claims					
4) Claim(s) 142,144,146-148,150-152,154-156 and 158-160 is/are pending in the application.					
4a) Of the above claim(s) is/are withdrawn from consideration.					
5) Claim(s) is/are allowed.					
6)[☑ Claim(s) <u>142,144,146-148,150-152,154-156 and 158-160</u> is/are rejected.					
7) Claim(s) is/are objected to.					
8) Claim(s) are subject to restriction and/or election requirement.					
Application Papers					
9) The specification is objected to by the Examiner.					
10) The drawing(s) filed on is/are: a) accepted or b) objected to by the Examiner.					
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).					
11) ☐ The proposed drawing correction filed on is: a) ☐ approved b) ☐ disapproved by the Examiner.					
If approved, corrected drawings are required in reply to this Office action.					
12) The oath or declaration is objected to by the Examiner.					
Priority under 35 U.S.C. §§ 119 and 120					
13) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).					
a) All b) Some * c) None of:					
1. Certified copies of the priority documents have been received.					
2. Certified copies of the priority documents have been received in Application No					
3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).					
* See the attached detailed Office action for a list of the certified copies not received.					
14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).					
a) ☐ The translation of the foreign language provisional application has been received. 15)☐ Acknowledgment is made of a claim for domestic priority under 35 U.S.C. §§ 120 and/or 121.					
Attachment(s)					
1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449) Paper No(s) 6) Other:					

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### **DETAILED ACTION**

## Claim Rejections - 35 USC § 112

1. The following is a quotation of the second paragraph of 35 U.S.C. 112:

The specification shall conclude with one or more claims particularly pointing out and distinctly claiming the subject matter which the applicant regards as his invention.

2. Claim 142 is rejected under 35 U.S.C.112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which applicant regards as the invention.

In lines 16-18 of claim 142, the language of "in concentration suitable for the selective removal of said residue relative to any exposed metal on said semiconductor substrate" is vague and indefinite because it is unclear what concentration is defined as "concentration suitable for the selective removal of said residue" since there is no guideline in the claim of how to present the conditioning solution "in concentration suitable for the selective removal of said residue to any exposed metal"

# Claim Rejections - 35 USC § 103

- 3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 4. Claims 142. 144. 146-148, 150-152, 154-156 are rejected under 35 U.S.C. 103(a) as being unpatentable over Schellenberger et al. ( US 5,714,203 ) in view of Freiberger (US 5,219,791) and further in view of Small et al (US 6,248,704)

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Schellenberger discloses a method for drying semiconductor substrate including the step of dipping the substrate in a cleaning solution. This solution comprises of:

hydrofluoric acid (HF), which reads on a fluorine source ( col 3, lines 55-56 ) acids such as hydrochloric acid (HCl), phosphoric acid ( $H_3PO_4$ ), which reads on a complimentary acid ( col 3, lines 58-59 )

alcohol (col 3, lines 56-57)

an organic acid (citric acid) (col 3, lines 57-58) reads on a surface passivation agent especially since an organic acid such as citric acid is defined as a surface passivation agent in page 6 of the specification.

Since Schellenberger's cleaning solution contains up to 80 % of alcohol (a known non-aqueous solvent, see prior art of record for evidence of this basis) (col 3, lines 63-64), it reads on a substantially free of water solution because the claimed substantially non-aqueous/free of water solution as defined as a solution that has approximately 80-95% of alcohol in page 10 of the specification.

Unlike the instant claimed inventions as per claims 142,150, Schellenberger does not specifically disclose using ethylene glycol ( a known non-aqueous solvent/ alcohol ) in the cleaning solution although Schellenberger does discloses using alcohol in the cleaning solution.

However. Freiberger, in a method of precleaning semiconductor device, teaches that ethylene glycol can be mixed with HF in a cleaning solution (col 7, lines 36-38)

Therefore, one skilled in the art would have found it obvious to modify

Schellenberger 's cleaning solution by using ethylene glycol in the solution in view of

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Freiberger teaching because Schellenberger suggests that alcohol up to 80 % weight can be used in the cleaning solution and Freiberger teaches that ethylene glycol acts as a means to dilute the cleaning formula/composition (col 7, lines 40-41)

Schellenberger and Freiberger differs from the instant claimed invention as per claim 142 by using a surface passivation agent of citric acid instead of ascorbic acid However, Small, in a composition for cleaning organic etched residue, teaches that organic acids such as citric acid, ascorbic acid can be used in a semiconductor cleaning composition (col 6, lines 65-67; col 7, lines 1-3)

Hence, one skilled in the art would have found it obvious to substitute

Schellenberger and Freiberger surface passivation agent of citric acid with ascorbic acid in view of Small teaching because both acids are known acid used in cleaning solution, thus the substitution of one for the other would have produced an expected result.

For the purpose of examination, the language of "said fluorine.....in concentration suitable for the selective removal of said residue relative to any exposed metal on said semiconductor substrate", as best understood by the examiner, implies that the claimed conditioning solution contains the claimed elements in a defined concentration (page 10 of the specification) to remove the residue. Since Schellenberger as modified by Freiberger and Small discloses using a cleaning solution contains the same claimed chemicals (HF acid. phosphoric acid, ascorbic acid and ethylene glycol) having the same concentration as the claimed cleaning solution, it would have been obvious that Schellenberger's modified cleaning solution would have performed the same function

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(for the selective removal of said residue relative to any exposed metal on said semiconductor substrate) as the claimed cleaning solution.

In addition, the examiner notes that the language of "for the selective removal of said residue relative to any exposed metal on said semiconductor substrate" is a recitation of the intended use of the claimed invention. A recitation of the intended use of the claimed invention must result in a structural difference between the claimed invention and the prior art in order to patentably distinguish the claimed invention from the prior art. If the prior art structure/composition is capable of performing the intended use, then it meets the claim. In a claim drawn to a process of making, the intended use must result in a manipulative difference as compared to the prior art. See *In re Casey*, 152 USPQ 235 (CCPA 1967) and *In re Otto*, 136 USPQ 458, 459 (CCPA 1963).

Regarding claims 144, 152, since the resulting cleaning solution of Schellenberger, Freiberger and Small contains the same passivation agent (ascorbic acid) as the claimed cleaning solution, it would have been obvious that Schellenberger, Freiberger and Small ascorbic acid would have performed the same function (contributes to the selective removal by the cleaning solution by passivating any exposed metal on the semiconductor substrate) as the claimed cleaning solution.

Regarding claims 146-147, 154-155, it is noted in page 14 of the specification, the applicants defines that the low pH of the conditioning solution tends to allow HF present in the solution to exists as molecular HF. Since Schellenberger discloses that his solution having a pH value of less than 7 (col 3, lines 17-18), it is inherent that the HF in

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Schellenberger solution remaining in molecular form and contributes to the selective removal of the cleaning solution.

Regarding claims 148. 156, it is noted in page 11 of the specification, the applicants defines that the sufficient concentration of the claimed elements in the cleaning solution as (0.01%-5.0% HF. 80-99% alcohol, 0.003-1.0% complimentary acid, 0.001-1.0% of citric acid) to suppress the solubility of aluminum fluoride. Since Schellenberger, Freiberger and Small solution contains the same elements having the concentration of (0-50% acids, 0-80% alcohol), which reads on the claimed concentration, it would be obvious that Schellenberger, Freiberger and Small solution concentration would have suppressed the solubility of aluminum fluoride.

Regarding claim 151. since Schellenberger's cleaning solution contains up to 80% of acohol (a known non-aqueous solvent, see prior art of record for evidence of this basis ) (col 3. lines 63-64), it reads on a substantially non-aqueous solution because the claimed substantially non-aqueous solution as defined as a solution that has approximately 8—95% of alcohol in page 10 of the specification.

5. Claims 158-160 are rejected under 35 U.S.C. 103(a) as being unpatentable over Schellenberger et al. ( US 5,714,203 ) in view of Ward et al (US 5,988,186 ) and further in view of Verhaverbeke et al (US 6,261,845 )

Schellenberger discloses a method for drying semiconductor substrate including the step of dipping the substrate in a cleaning solution. This solution comprises of: hydrofluoric acid (HF), which reads on a fluorine source ( col 3, lines 55-56 )

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acids such as phosphoric acid ( $H_3PO_4$ ), which reads on a complimentary acid (col 3, lines 58-59)

alcohol (col 3, lines 56-57)

an organic acid (citric acid) (col 3, lines 57-58) reads on a surface passivation agent especially since an organic acid such as citric acid is defined as a surface passivation agent in page 6 of the specification.

Since Schellenberger's cleaning solution contains up to 80 % of alcohol (a known non-aqueous solvent, see prior art of record for evidence of this basis) (col 3, lines 63-64), it reads on a substantially free of water solution because the claimed substantially non-aqueous/free of water solution as defined as a solution that has approximately 80-95% of alcohol in page 10 of the specification. Schellenberger also discloses that the HF in the solution removes metal contamination (col 3, lines 17-19), which reads on the cleaning solution is selective to removal of residues.

Unlike the instant claimed invention as per claims 158-160. Schellenberger does not specifically using propylene glycol in the cleaning solution although Schellenberger does discloses using alcohol in the cleaning solution.

However. Ward teaches an acidic semiconductor cleaning solution containing alcohol such as propylene glycol (col 4, lines 40-42)

Hence, one skilled in the art would have found it obvious to modify Schellenberger's cleaning solution by using propylene glycol in the solution in view of Ward teaching because Schellenberger suggests that alcohol can be used in the cleaning solution and Ward teaches that solvent/alcohol which can be used in the semiconductor cleaning

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solution include and not limit to polyhydric alcohol such as prolylene glycol (col 4, lines 40-42)

Schellenberger's cleaning solution differs from the claimed cleaning solution as per claim 158 by having addictives such as surfactant, solid addictive whereas the claimed cleaning solution consisting essentially of :HF, phosphoric acid/hydrochloric acid, alcohol/propylene glycol and citric acid.

However, Verhaerbeke, in a method and system for determining chemical concentration of semiconductor cleaning solution, teaches that the concentrations of the chemicals in the wet processing stream/cleaning liquid, degree of cleaning are variables that can be calculated (col 8, lines 33-35)

Since Schellenberger already discloses using 0-50 wt% of acids, 0-80 wt% of alcohol, 0-5 wt% of surfactant and 0-50 wt % of solid addictive (col 3, lines 63-65) in the cleaning solution, one skilled in the art would have found it obvious to adjust/calculate the concentration of the components in Schellenberger cleaning solution in view of Verhaerbeke's teaching using routine experimentation to achieve a cleaning solution consisting essentially of :HF, phosphoric acid, alcohol/propylene glycol and citric acid. It has been held that the discovery of an optimum value for result effective variables is within the purview of routine experimentation by the person of ordinary skill in the art. In re Boesch, 617 F.2d 272, 276, 205 USPQ 215, 219 (CCPA 1980)

The limitations of claims 159-160 have been discussed above.

7. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure.

Jagannathan et al. (US 5,304,284) discloses that alcohols are non-aqueous solvents (col 5, lines 46-48)

## Response to Arguments

8. Applicant's arguments with respect to claims 142, 144, 146-148, 150-152, 154-156. 158-160 (filed on 11/18/2002) have been considered but are moot in view of the new ground(s) of rejection.

#### Conclusion

9. Any inquiry concerning this communication or earlier communications from the examiner should be directed to LAN VINH whose telephone number is 703 305-6302. The examiner can normally be reached on Monday-Friday 8:30 -6:00 PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor. BENJAMIN L UTECH can be reached on 703 308-3836. The fax phone numbers for the organization where this application or proceeding is assigned are 703 872-9310 for regular communications and 703 872-9311 for After Final communications.

January 16, 2003